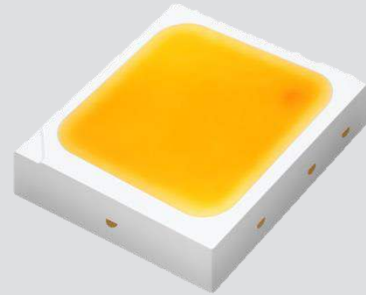


Middle Power LED Series  
3030

LM301A  
CRI 90



#### Features & Benefits

- Superior mid power LED with wide over-drive range up to 1.5W
- Mold resin for high reliability
- Standard form factor for design flexibility (3.0 × 3.0 mm)

## Table of Contents

1.	Characteristics	-----	3
2.	Product Code Information	-----	6
3.	Typical Characteristics Graphs	-----	19
4.	Outline Drawing & Dimension	-----	22
5.	Reliability Test Items & Conditions	-----	23
6.	Soldering Conditions	-----	24
7.	Tape & Reel	-----	25
8.	Label Structure	-----	27
9.	Packing Structure	-----	28
10.	Precautions in Handling & Use	-----	31

## 1. Characteristics

### a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	$T_a$	-40 ~ +85	°C	-
Storage Temperature	$T_{stg}$	-40 ~ +100	°C	-
LED Junction Temperature	$T_j$	125	°C	-
Forward Current	$I_F$	500	mA	-
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	5	kV	-

**b) Electro-optical Characteristics ( $I_f = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )**

Item	Unit	Rank	Bin	Min.	Typ.	Max.
Forward Voltage (V)	V	WA	AY	2.6	-	2.7
			AZ	2.7	-	2.8
			A1	2.8	-	2.9
			A2	2.9	-	3.0
			A3	3.0	-	3.1
Reverse Voltage (@ 5 mA)	V			0.7	-	1.2
Color Rendering Index ( $R_a$ )	-			90	-	-
Special CRI (R9)	-			50	-	-
Thermal Resistance (junction to solder point)	$^\circ\text{C/W}$			-	7	-
Beam Angle	$^\circ$			-	115	-

**Note:**

Samsung maintains measurement tolerance of: forward voltage =  $\pm 0.1 \text{ V}$ , CRI =  $\pm 3$ , R9 =  $\pm 6.5$

**b) Electro-optical Characteristics ( $T_s = 85\text{ }^\circ\text{C}$ )**

Item	CRI	Nominal CCT (K)	SY		SZ		SA		SB		SC		Current	
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
			14	16	16	18	18	20	20	22	22	24		65mA
			34	38	38	42	42	46	46	50	50	54		150mA
			72	80	80	88	88	96	96	104	104	112	350mA	
Luminous Flux ( $\Phi_v$ )	90	2700												
		3000												
		3500												
		4000												
		5000												
		5700												
		6500												

**Note:**

Samsung maintains measurement tolerance of: forward voltage =  $\pm 0.1\text{V}$ , luminous flux =  $\pm 5\%$ , CRI =  $\pm 3$ , R9 =  $\pm 6.5$

Calculated luminous flux values at 65mA and 350mA are for reference only.

## 2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	M	W	H	T	3	2	8	F	D	7	W	A	R	0	S	0

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package Middle Power	SPM	
4 5	Color	WH	White
6	Product Version	T	
7 8 9	Form Factor	328	3.0 x 3.0 x 0.65 mm; 2 pads; 1chip;
10	Sorting Current (mA)	F	150 mA
11	Chromaticity Coordinates	D	ANSI Standard
12	CRI	7	Min. 90
13 14	Forward Voltage (V)	WA	2.6~3.1V
15 16	CCT (K)	W★ V★ U★ T★ R★ Q★ P★	2700 3000 3500 4000 5000 5700 6500 Bin Code: W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RH, RJ, RK, RL Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9, QA, QB, QC, QH, QJ, QK, QL P1, P2, P3, P4, P5, P6, P7, P8, P9, PA, PB, PC, PH, PJ, PK, PL ★ : Cool white: "0" (Whole bin) or "K" (Kitting bin)
17 18	Luminous Flux	S0	Bin Code: SZ, SA, SB, SC

a) Luminous Flux Bins ( $I_f = 150 \text{ mA}$ ,  $T_s = 85^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Flux Bin	Flux Range ( $\Phi_v$ , lm)
90	2700	SPMWHT328FD7WAW★S0	SZ	38 ~ 42
			SA	42 ~ 46
	3000	SPMWHT328FD7WAV★S0	SA	42 ~ 46
			SB	46 ~ 50
	3500	SPMWHT328FD7WAW★S0	SA	42 ~ 46
			SB	46 ~ 50
	4000	SPMWHT328FD7WAT★S0	SB	46 ~ 50
			SC	50 ~ 54
	5000	SPMWHT328FD7WAR★S0	SA	42 ~ 46
			SB	46 ~ 50
	5700	SPMWHT328FD7WAQ★S0	SA	42 ~ 46
			SB	46 ~ 50
	6500	SPMWHT328FD7WAP★S0	SA	42 ~ 46
			SB	46 ~ 50

**Note:**

"★" can be "0" (Whole bin) or "K" (Kitting bin) of the color binning

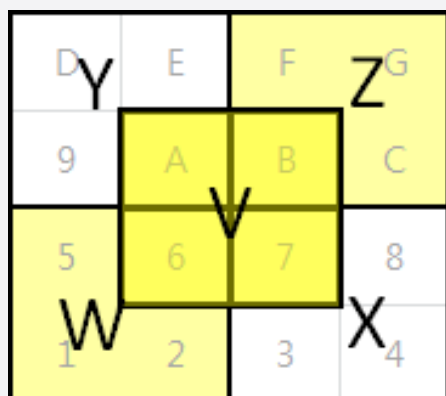
## b) Kitting rule

### 1) Kitting bin Concept

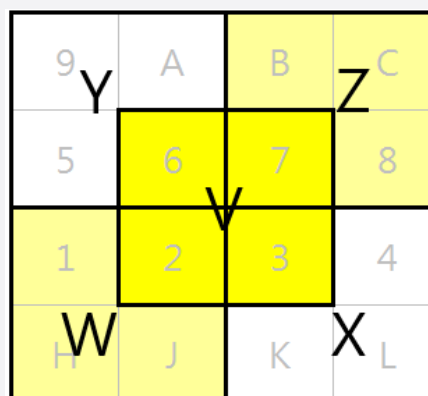
- Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, Im).
- A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (AY+AY), (AZ+AZ), (A1+A1), (A2+A2) or (A3+A3).
- A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)

#### [Kitting example]

##### [2700K ~ 4000K]



##### [5000K ~ 6500K]



#### [Binning Information]

Item	CCT	Bin #1	Bin #2
VF	-	AY	AY
		AZ	AZ
		A1	A1
		A2	A2
		A3	A3
CIE	2700K ~ 4000K	W (1, 2, 5, 6 bin)	Z (B, C, F, G bin)
		V (6, 7, A, B bin)	V (6, 7, A, B bin)
		X (3, 4, 7, 8 bin)	Y (9, A, D, E bin)
	5000K ~ 6500K	W (H, J, 1, 2 bin)	Z (7, 8, B, C bin)
		V (2, 3, 6, 7 bin)	V (2, 3, 6, 7 bin)
		X (K, L, 3, 4 bin)	Y (5, 6, 9, A bin)
IV	-	SZ	SZ
		SA	SA
		SB	SB
		SC	SC

※ Each of V,W,X,Y and Z can be one bin without details division.



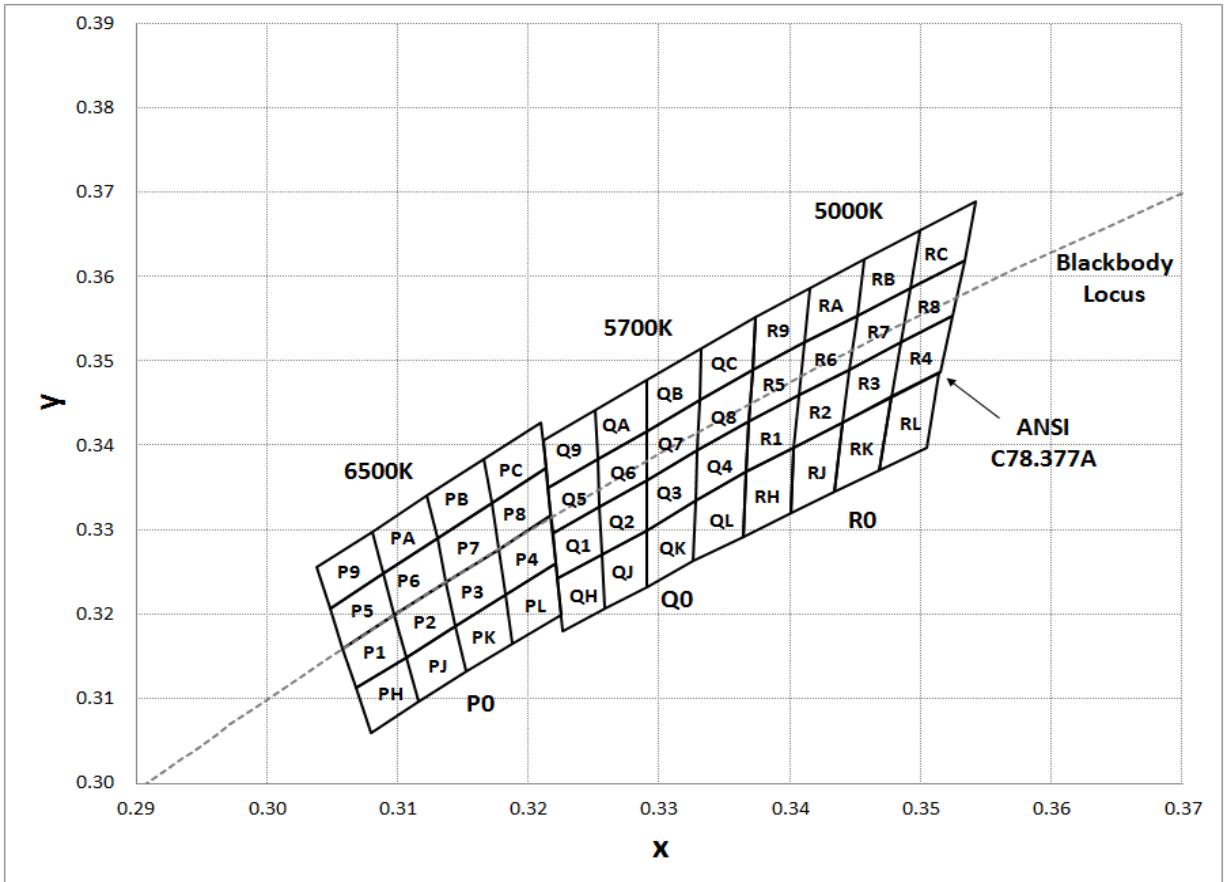
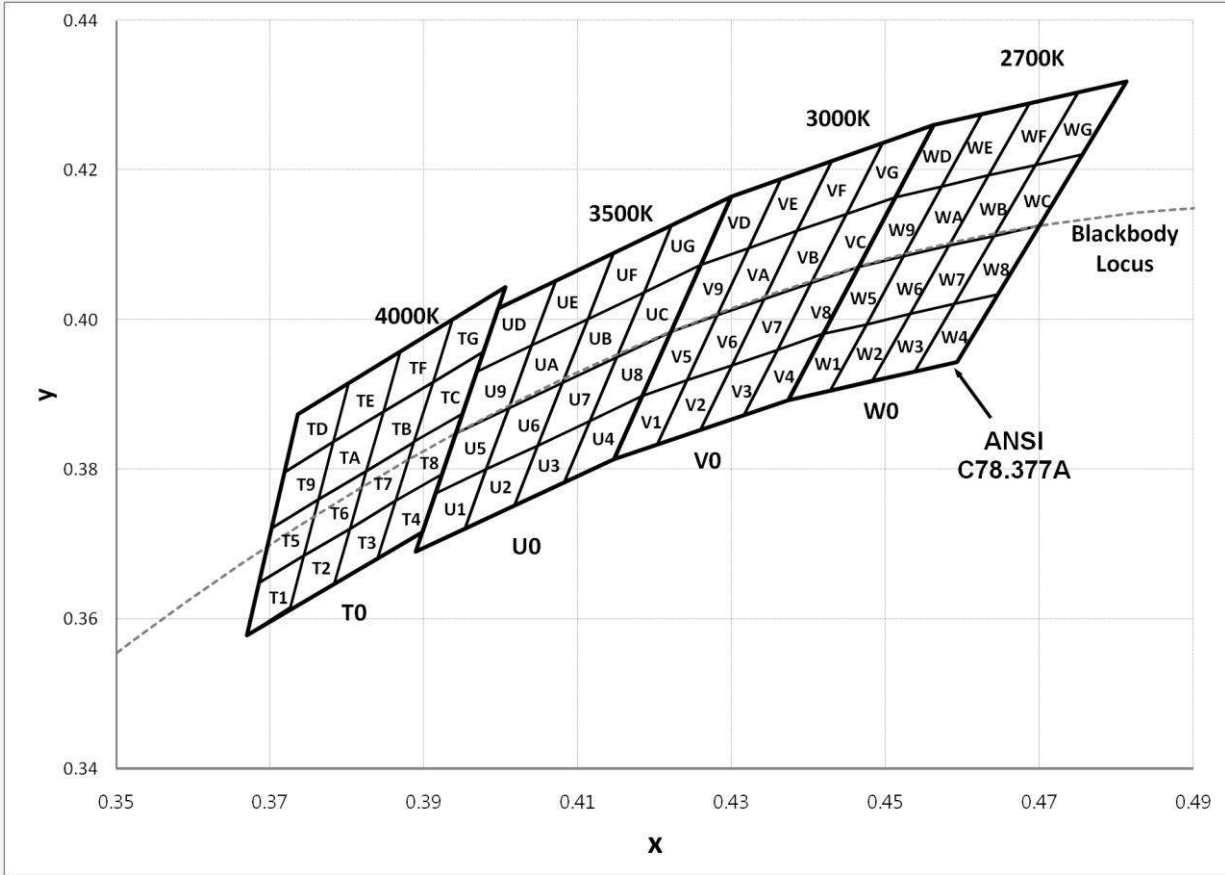
c) Color Bins ( $I_f = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

CRI (R <sub>a</sub> ) Min.	Nominal CCT (K)	Product Code	Color Rank	Chromaticity Bins
90	2700	SPMWHT328FD7WAW0S0	W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG
		SPMWHT328FD7WAWKS0	WK (Kitting bin)	WV, WW, WX, WY, WZ
	3000	SPMWHT328FD7WAV0S0	V0 (Whole bin)	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
		SPMWHT328FD7WAVKS0	VK (Kitting bin)	VV, VW, VX, VY, VZ
	3500	SPMWHT328FD7WAU0S0	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
		SPMWHT328FD7WAUKS0	UK (Kitting bin)	UV, UW, UX, UY, UZ
	4000	SPMWHT328FD7WAT0S0	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
		SPMWHT328FD7WATKS0	TK (Kitting bin)	TV, TW, TX, TY, TZ
	5000	SPMWHT328FD7WAR0S0	R0 (Whole bin)	R1, R2, R3, R4, R5, R6, R7, R8, R9 RA, RB, RC, RD, RE, RF, RG, RH, RI, RJ, RK, RL
		SPMWHT328FD7WARKS0	RK (Kitting bin)	RV, RW, RX, RY, RZ
	5700	SPMWHT328FD7WAQ0S0	Q0 (Whole bin)	Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9 QA, QB, QC, QD, QE, QF, QG, QH, QI, QJ, QK, QL
		SPMWHT328FD7WAQKS0	QK (Kitting bin)	QV, QW, QX, QY, QZ
	6500	SPMWHT328FD7WAP0S0	P0 (Whole bin)	P1, P2, P3, P4, P5, P6, P7, P8, P9 PA, PB, PC, PD, PE, PF, PG, PH, PI, PJ, PK, PL
		SPMWHT328FD7WAPKS0	PK (Kitting bin)	PV, PW, PX, PY, PZ

d) Voltage Bins ( $I_f = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
-	-	-	WA	AY	2.6 ~ 2.7
				AZ	2.7 ~ 2.8
				A1	2.8 ~ 2.9
				A2	2.9 ~ 3.0
				A3	3.0 ~ 3.1

e) Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )



### e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>W rank (2700 K)</b>					
W1	0.4373	0.3893	W9	0.4465	0.4071
	0.4418	0.3981		0.4513	0.4164
	0.4475	0.3994		0.4573	0.4178
	0.4428	0.3906		0.4523	0.4085
W2	0.4428	0.3906	WA	0.4523	0.4085
	0.4475	0.3994		0.4573	0.4178
	0.4532	0.4008		0.4634	0.4193
W3	0.4483	0.3919	WB	0.4582	0.4099
	0.4532	0.4008		0.4634	0.4193
	0.4589	0.4021		0.4695	0.4207
	0.4538	0.3931		0.4641	0.4112
W4	0.4538	0.3931	WC	0.4641	0.4112
	0.4589	0.4021		0.4695	0.4207
	0.4646	0.4034		0.4756	0.4221
	0.4593	0.3944		0.4700	0.4126
W5	0.4418	0.3981	WD	0.4513	0.4164
	0.4465	0.4071		0.4562	0.4260
	0.4523	0.4085		0.4624	0.4274
	0.4475	0.3994		0.4573	0.4178
W6	0.4475	0.3994	WE	0.4573	0.4178
	0.4523	0.4085		0.4624	0.4274
	0.4582	0.4099		0.4687	0.4289
	0.4532	0.4008		0.4634	0.4193
W7	0.4532	0.4008	WF	0.4634	0.4193
	0.4582	0.4099		0.4687	0.4289
	0.4641	0.4112		0.4750	0.4304
	0.4589	0.4021		0.4695	0.4207
W8	0.4589	0.4021	WG	0.4695	0.4207
	0.4641	0.4112		0.4750	0.4304
	0.4700	0.4126		0.4813	0.4319
	0.4646	0.4034		0.4756	0.4221

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>V rank (3000 K)</b>					
V1	0.4147	0.3814	V9	0.4221	0.3984
	0.4183	0.3898		0.4259	0.4073
	0.4242	0.3919		0.4322	0.4096
	0.4203	0.3833		0.4281	0.4006
V2	0.4203	0.3833	VA	0.4281	0.4006
	0.4242	0.3919		0.4322	0.4096
	0.4300	0.3939		0.4385	0.4119
V3	0.4259	0.3853	VB	0.4342	0.4028
	0.4300	0.3939		0.4385	0.4119
	0.4359	0.3960		0.4449	0.4141
	0.4316	0.3873		0.4403	0.4049
V4	0.4316	0.3873	VC	0.4403	0.4049
	0.4359	0.3960		0.4449	0.4141
	0.4418	0.3981		0.4513	0.4164
	0.4373	0.3893		0.4465	0.4071
V5	0.4183	0.3898	VD	0.4259	0.4073
	0.4221	0.3984		0.4299	0.4165
	0.4281	0.4006		0.4364	0.4188
	0.4242	0.3919		0.4322	0.4096
V6	0.4242	0.3919	VE	0.4322	0.4096
	0.4281	0.4006		0.4364	0.4188
	0.4342	0.4028		0.4430	0.4212
	0.4300	0.3939		0.4385	0.4119
V7	0.4300	0.3939	VF	0.4385	0.4119
	0.4342	0.4028		0.4430	0.4212
	0.4403	0.4049		0.4496	0.4236
	0.4359	0.3960		0.4449	0.4141
V8	0.4359	0.3960	VG	0.4449	0.4141
	0.4403	0.4049		0.4496	0.4236
	0.4465	0.4071		0.4562	0.4260
	0.4418	0.3981		0.4513	0.4164

e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>U rank (3500 K)</b>					
U1	0.3889	0.3690	U9	0.3941	0.3848
	0.3915	0.3768		0.3968	0.3930
	0.3981	0.3800		0.4040	0.3966
	0.3953	0.3720		0.4010	0.3882
U2	0.3953	0.3720	UA	0.4010	0.3882
	0.3981	0.3800		0.4040	0.3966
	0.4048	0.3832		0.4113	0.4001
	0.4017	0.3751		0.4080	0.3916
U3	0.4017	0.3751	UB	0.4080	0.3916
	0.4048	0.3832		0.4113	0.4001
	0.4116	0.3865		0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
U4	0.4082	0.3782	UC	0.4150	0.3950
	0.4116	0.3865		0.4186	0.4037
	0.4183	0.3898		0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
U5	0.3915	0.3768	UD	0.3968	0.3930
	0.3941	0.3848		0.3996	0.4015
	0.4010	0.3882		0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
U6	0.3981	0.3800	UE	0.4040	0.3966
	0.4010	0.3882		0.4071	0.4052
	0.4080	0.3916		0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
U7	0.4048	0.3832	UF	0.4113	0.4001
	0.4080	0.3916		0.4146	0.4089
	0.4150	0.3950		0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
U8	0.4116	0.3865	UG	0.4186	0.4037
	0.4150	0.3950		0.4222	0.4127
	0.4221	0.3984		0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>T rank (4000 K)</b>					
T1	0.3670	0.3578	T9	0.3702	0.3722
	0.3726	0.3612		0.3763	0.3760
	0.3744	0.3685		0.3782	0.3837
	0.3686	0.3649		0.3719	0.3797
T2	0.3726	0.3612	TA	0.3763	0.3760
	0.3783	0.3646		0.3825	0.3798
	0.3804	0.3721		0.3847	0.3877
	0.3744	0.3685		0.3782	0.3837
T3	0.3783	0.3646	TB	0.3825	0.3798
	0.3840	0.3681		0.3887	0.3836
	0.3863	0.3758		0.3912	0.3917
	0.3804	0.3721		0.3847	0.3877
T4	0.3840	0.3681	TC	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3924	0.3794		0.3978	0.3958
	0.3863	0.3758		0.3912	0.3917
T5	0.3686	0.3649	TD	0.3719	0.3797
	0.3744	0.3685		0.3782	0.3837
	0.3763	0.3760		0.3802	0.3916
	0.3702	0.3722		0.3736	0.3874
T6	0.3744	0.3685	TE	0.3782	0.3837
	0.3804	0.3721		0.3847	0.3877
	0.3825	0.3798		0.3869	0.3958
	0.3763	0.376		0.3802	0.3916
T7	0.3804	0.3721	TF	0.3847	0.3877
	0.3863	0.3758		0.3912	0.3917
	0.3887	0.3836		0.3937	0.4001
	0.3825	0.3798		0.3869	0.3958
T8	0.3863	0.3758	TG	0.3912	0.3917
	0.3924	0.3794		0.3978	0.3958
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3836		0.3937	0.4001



## e) Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>R rank (5000 K)</b>					
R1	0.3366	0.3369	R9	0.3371	0.3490
	0.3369	0.3430		0.3374	0.3553
	0.3407	0.3460		0.3415	0.3587
	0.3403	0.3398		0.3411	0.3522
R2	0.3403	0.3398	RA	0.3411	0.3522
	0.3407	0.3460		0.3415	0.3587
	0.3446	0.3491		0.3457	0.3621
	0.3440	0.3427		0.3451	0.3554
R3	0.3440	0.3427	RB	0.3451	0.3554
	0.3446	0.3491		0.3457	0.3621
	0.3485	0.3522		0.3500	0.3655
	0.3478	0.3457		0.3492	0.3587
R4	0.3478	0.3457	RC	0.3492	0.3587
	0.3485	0.3522		0.3500	0.3655
	0.3524	0.3554		0.3542	0.3690
	0.3515	0.3487		0.3533	0.3620
R5	0.3369	0.3430	RH	0.3364	0.3292
	0.3371	0.3490		0.3400	0.3320
	0.3411	0.3522		0.3403	0.3398
	0.3407	0.3460		0.3366	0.3369
R6	0.3407	0.3460	RJ	0.3400	0.3320
	0.3411	0.3522		0.3434	0.3345
	0.3451	0.3554		0.3440	0.3427
	0.3446	0.3491		0.3403	0.3398
R7	0.3446	0.3491	RK	0.3434	0.3345
	0.3451	0.3554		0.3468	0.3371
	0.3492	0.3587		0.3477	0.3458
	0.3485	0.3522		0.3440	0.3427
R8	0.3485	0.3522	RL	0.3468	0.3371
	0.3492	0.3587		0.3504	0.3398
	0.3533	0.3620		0.3514	0.3487
	0.3524	0.3554		0.3477	0.3458

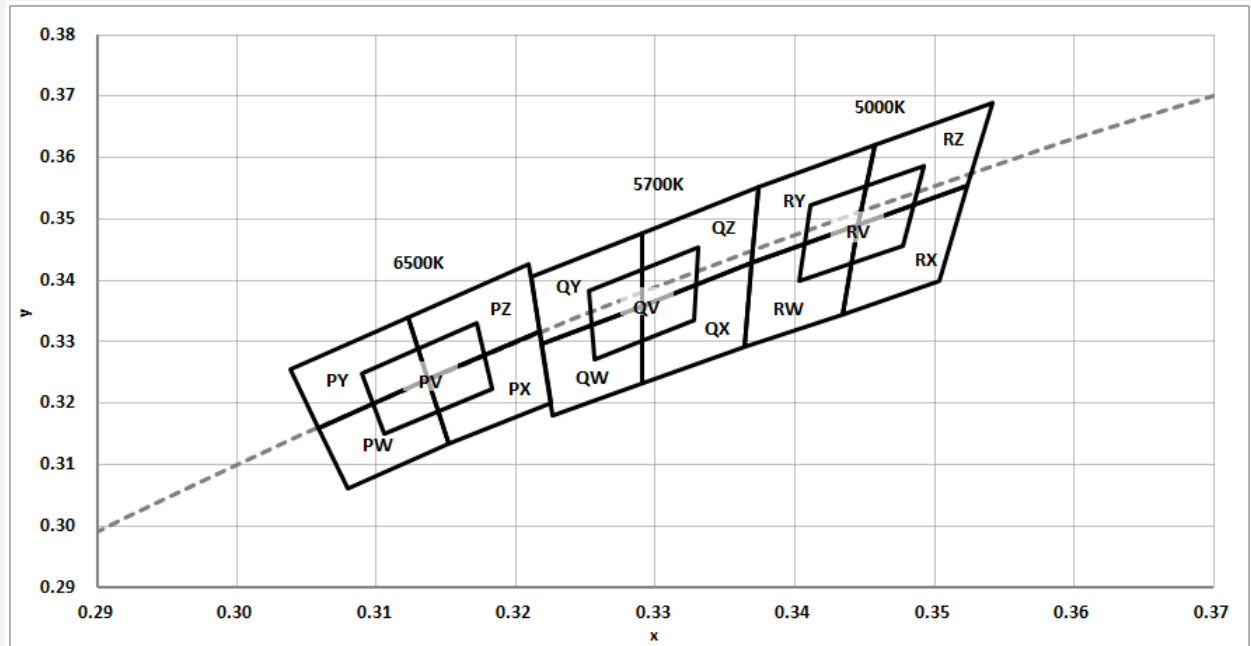
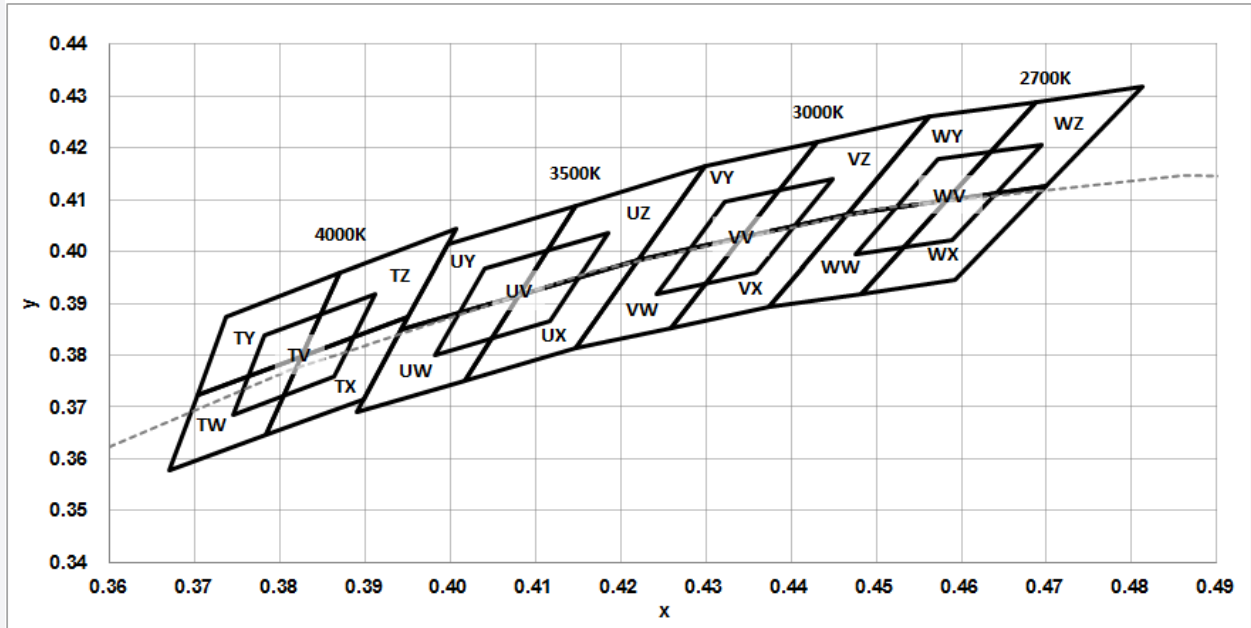
Region	CIE x	CIE y	Region	CIE x	CIE y
<b>Q rank (5700 K)</b>					
Q1	0.3222	0.3243	Q9	0.3215	0.3350
	0.3219	0.3297		0.3211	0.3406
	0.3254	0.3328		0.3251	0.3442
	0.3256	0.3272		0.3253	0.3384
Q2	0.3256	0.3272	QA	0.3253	0.3384
	0.3254	0.3328		0.3251	0.3442
	0.3290	0.3359		0.3290	0.3478
	0.3290	0.3300		0.3290	0.3417
Q3	0.3290	0.3300	QB	0.3290	0.3417
	0.3290	0.3359		0.3290	0.3478
	0.3329	0.3394		0.3332	0.3515
	0.3328	0.3335		0.3331	0.3454
Q4	0.3328	0.3335	QC	0.3331	0.3454
	0.3329	0.3394		0.3332	0.3515
	0.3369	0.3430		0.3374	0.3553
	0.3366	0.3369		0.3371	0.3490
Q5	0.3219	0.3297	QH	0.3226	0.3180
	0.3215	0.3350		0.3258	0.3207
	0.3253	0.3384		0.3256	0.3272
	0.3254	0.3328		0.3222	0.3243
Q6	0.3254	0.3328	QJ	0.3258	0.3207
	0.3253	0.3384		0.3290	0.3233
	0.3290	0.3417		0.3290	0.3300
	0.3290	0.3359		0.3256	0.3272
Q7	0.3290	0.3359	QK	0.3290	0.3233
	0.3290	0.3417		0.3326	0.3263
	0.3331	0.3454		0.3328	0.3335
	0.3329	0.3394		0.3290	0.3300
Q8	0.3329	0.3394	QL	0.3326	0.3263
	0.3331	0.3454		0.3364	0.3292
	0.3371	0.3490		0.3366	0.3369
	0.3369	0.3430		0.3328	0.3335

## e) Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>P rank (6500 K)</b>					
P1	0.3068	0.3113	P9	0.3048	0.3207
	0.3106	0.3150		0.3089	0.3249
	0.3098	0.3199		0.3080	0.3298
	0.3058	0.3160		0.3038	0.3256
P2	0.3106	0.3150	PA	0.3089	0.3249
	0.3144	0.3186		0.3130	0.3290
	0.3137	0.3238		0.3123	0.3341
	0.3098	0.3199		0.3080	0.3298
P3	0.3144	0.3186	PB	0.3130	0.3290
	0.3183	0.3224		0.3172	0.3332
	0.3177	0.3278		0.3166	0.3384
	0.3137	0.3238		0.3123	0.3341
P4	0.3183	0.3224	PC	0.3172	0.3332
	0.3221	0.3261		0.3213	0.3373
	0.3217	0.3317		0.3209	0.3427
	0.3177	0.3278		0.3166	0.3384
P5	0.3058	0.3160	PH	0.3079	0.3060
	0.3098	0.3199		0.3115	0.3098
	0.3089	0.3249		0.3106	0.3150
	0.3048	0.3207		0.3068	0.3113
P6	0.3098	0.3199	PJ	0.3115	0.3098
	0.3137	0.3238		0.3152	0.3133
	0.3130	0.3290		0.3144	0.3186
	0.3089	0.3249		0.3106	0.3150
P7	0.3137	0.3238	PK	0.3152	0.3133
	0.3177	0.3278		0.3190	0.3170
	0.3172	0.3332		0.3183	0.3224
	0.3130	0.3290		0.3144	0.3186
P8	0.3177	0.3278	PL	0.3190	0.3170
	0.3217	0.3317		0.3225	0.3200
	0.3213	0.3373		0.3221	0.3261
	0.3172	0.3332		0.3183	0.3224

**Note:** Samsung maintains measurement tolerance of:  $C_x, C_y = \pm 0.005$

f) Kitting Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85^\circ\text{C}$ )



**Note:** Samsung maintains measurement tolerance of:  $C_x, C_y = \pm 0.005$



f) Kitting Chromaticity Region & Coordinates ( $I_F = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>W rank (2700 K)</b>					
WV	0.4475	0.3994			
	0.4589	0.4021			
	0.4695	0.4207			
	0.4573	0.4178			
WW	0.4373	0.3893	WY	0.4465	0.4071
	0.4483	0.3919		0.4582	0.4099
	0.4582	0.4099		0.4687	0.4289
	0.4465	0.4071		0.4562	0.4260
WX	0.4483	0.3919	WZ	0.4582	0.4099
	0.4593	0.3944		0.4700	0.4126
	0.4700	0.4126		0.4813	0.4319
	0.4582	0.4099		0.4687	0.4289

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>V rank (3000 K)</b>					
VV	0.4242	0.3919			
	0.4359	0.3960			
	0.4449	0.4141			
	0.4322	0.4096			
VW	0.4147	0.3814	VY	0.4221	0.3984
	0.4259	0.3853		0.4342	0.4028
	0.4342	0.4028		0.4430	0.4212
	0.4221	0.3984		0.4299	0.4165
VX	0.4259	0.3853	VZ	0.4342	0.4028
	0.4373	0.3893		0.4465	0.4071
	0.4465	0.4071		0.4562	0.4260
	0.4342	0.4028		0.4430	0.4212

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>U rank (3500 K)</b>					
UV	0.3981	0.3800			
	0.4116	0.3865			
	0.4186	0.4037			
	0.4040	0.3966			
UW	0.3889	0.3690	UY	0.3941	0.3848
	0.4017	0.3751		0.4080	0.3916
	0.4080	0.3916		0.4146	0.4089
	0.3941	0.3848		0.3996	0.4015
UX	0.4017	0.3751	UZ	0.4080	0.3916
	0.4147	0.3814		0.4221	0.3984
	0.4221	0.3984		0.4299	0.4165
	0.4080	0.3916		0.4146	0.4089

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>T rank (4000 K)</b>					
TV	0.3744	0.3685			
	0.3863	0.3758			
	0.3912	0.3917			
	0.3782	0.3837			
TW	0.3670	0.3578	TY	0.3702	0.3722
	0.3783	0.3646		0.3825	0.3798
	0.3825	0.3798		0.3869	0.3958
	0.3702	0.3722		0.3736	0.3874
TX	0.3783	0.3646	TZ	0.3825	0.3798
	0.3898	0.3716		0.3950	0.3875
	0.3950	0.3875		0.4006	0.4044
	0.3825	0.3798		0.3869	0.3958



## f) Kitting Chromaticity Region &amp; Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>R rank (5000 K)</b>					
RV	0.3403	0.3398			
	0.3478	0.3457			
	0.3492	0.3587			
	0.3411	0.3522			
RW	0.3364	0.3292	RY	0.3369	0.3430
	0.3434	0.3345		0.3446	0.3491
	0.3446	0.3491		0.3457	0.3621
	0.3369	0.3430		0.3374	0.3553
RX	0.3434	0.3345	RZ	0.3446	0.3491
	0.3504	0.3398		0.3524	0.3554
	0.3524	0.3554		0.3542	0.3690
	0.3446	0.3491		0.3457	0.3621

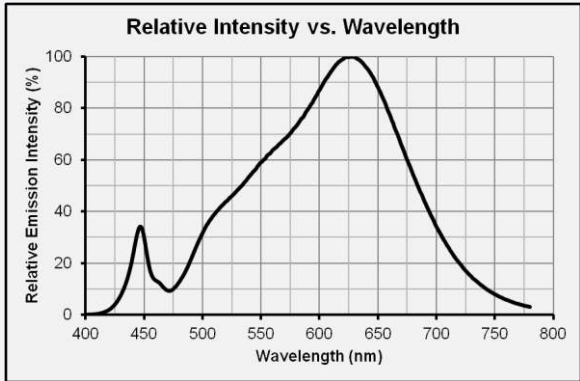
Region	CIE x	CIE y	Region	CIE x	CIE y
<b>Q rank (5700 K)</b>					
QV	0.3256	0.3272			
	0.3328	0.3335			
	0.3331	0.3454			
	0.3253	0.3384			
QW	0.3226	0.3180	QY	0.3219	0.3297
	0.3290	0.3233		0.3290	0.3359
	0.3290	0.3359		0.3290	0.3478
	0.3219	0.3297		0.3211	0.3406
QX	0.3290	0.3233	QZ	0.3290	0.3359
	0.3364	0.3292		0.3369	0.3430
	0.3369	0.3430		0.3374	0.3553
	0.3290	0.3359		0.3290	0.3478

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>P rank (6500 K)</b>					
PV	0.3106	0.3150			
	0.3183	0.3224			
	0.3172	0.3332			
	0.3089	0.3249			
PW	0.3079	0.3060	PY	0.3058	0.3160
	0.3152	0.3133		0.3137	0.3238
	0.3137	0.3238		0.3123	0.3341
	0.3058	0.3160		0.3038	0.3256
PX	0.3152	0.3133	PZ	0.3137	0.3238
	0.3225	0.3200		0.3217	0.3317
	0.3217	0.3317		0.3209	0.3427
	0.3137	0.3238		0.3123	0.3341

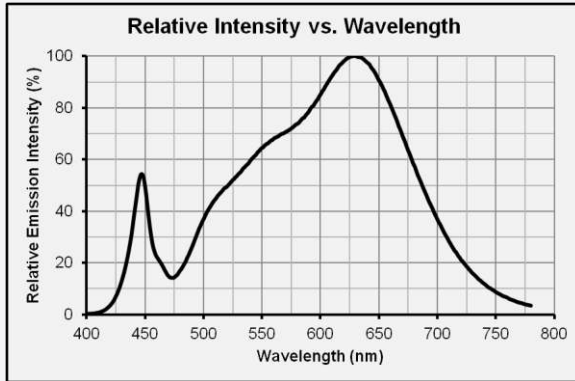
### 3. Typical Characteristics Graphs

#### a) Spectrum Distribution ( $I_f = 150 \text{ mA}$ , $T_s = 85 \text{ }^\circ\text{C}$ )

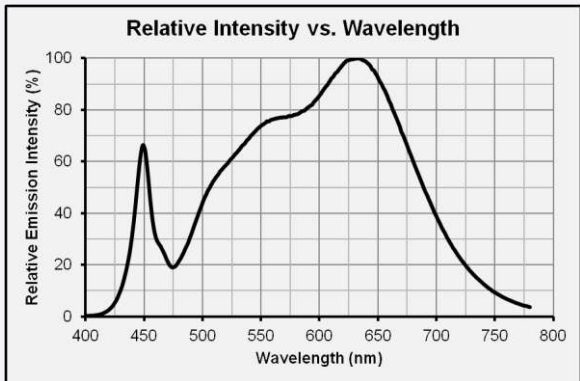
CCT: 2700K (90 CRI)



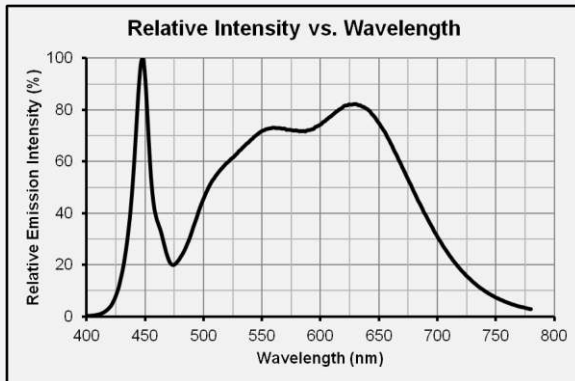
CCT: 3000K (90 CRI)



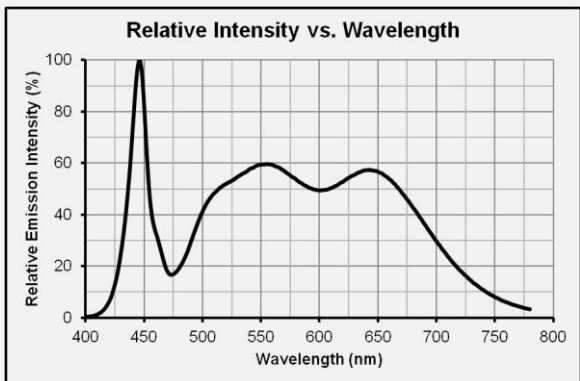
CCT: 3500K (90 CRI)



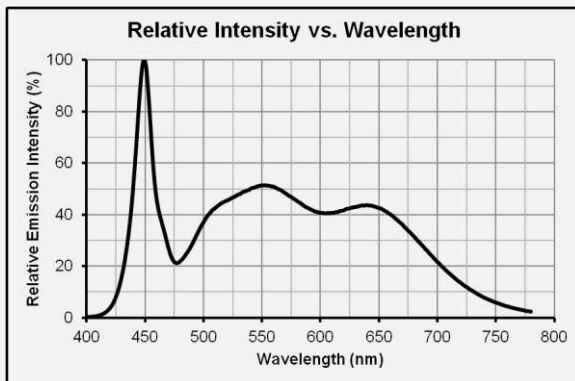
CCT: 4000K (90 CRI)



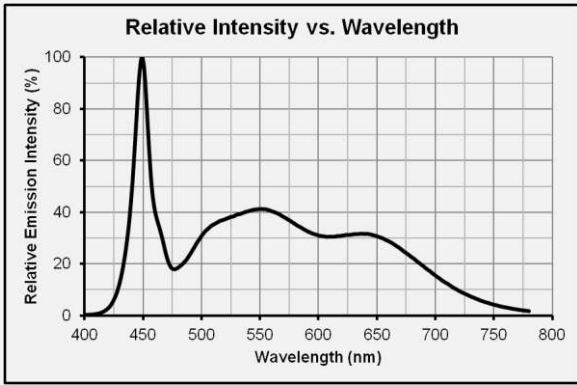
CCT: 5000K (90 CRI)



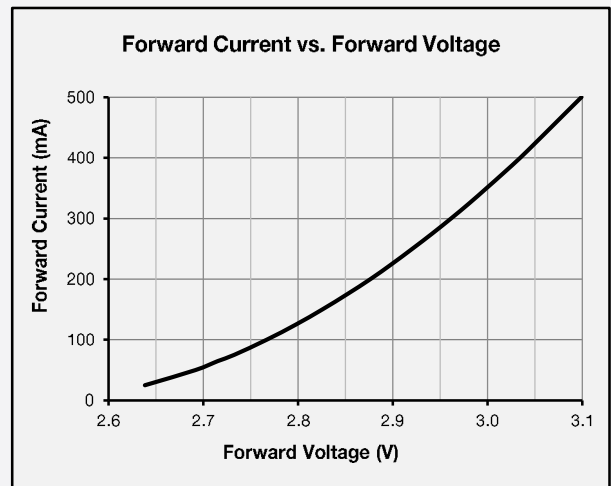
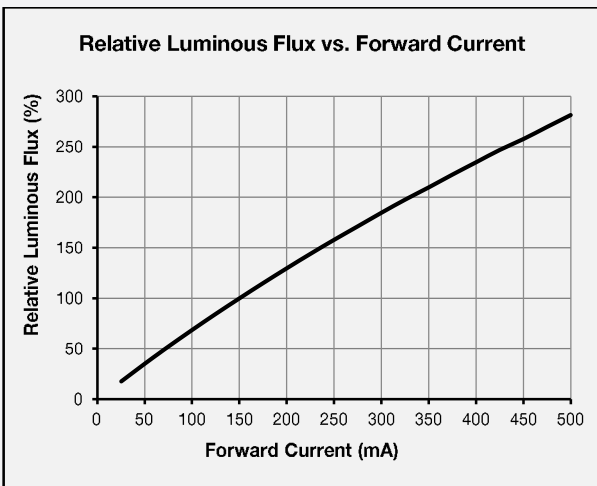
CCT: 5700K (90 CRI)



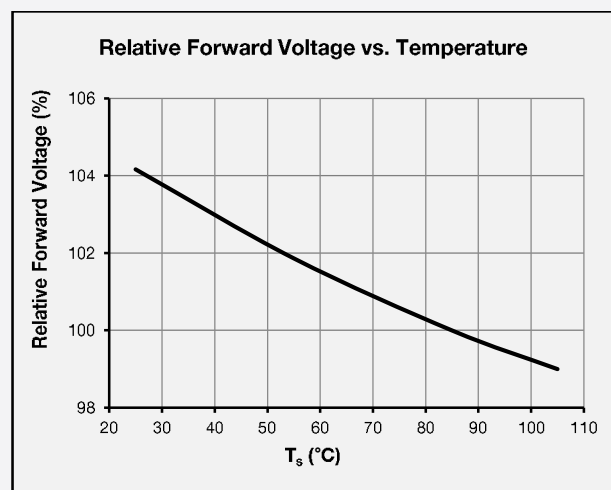
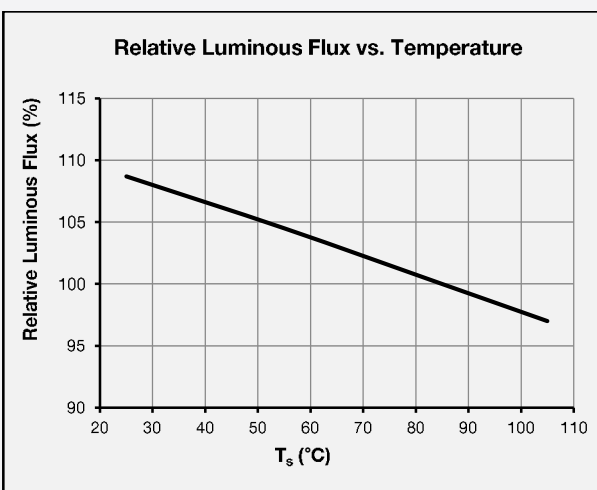
CCT: 6500K (90 CRI)



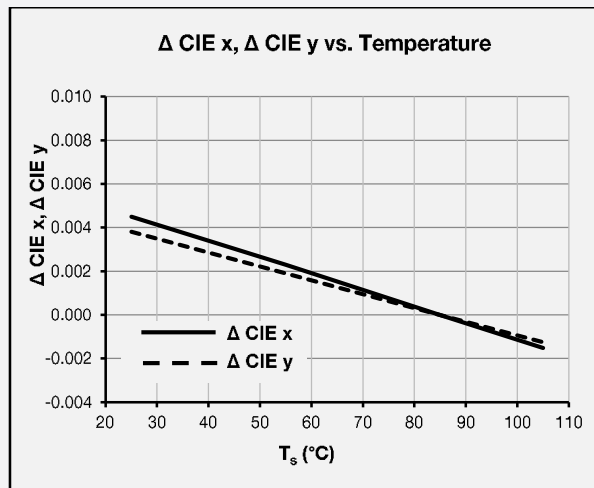
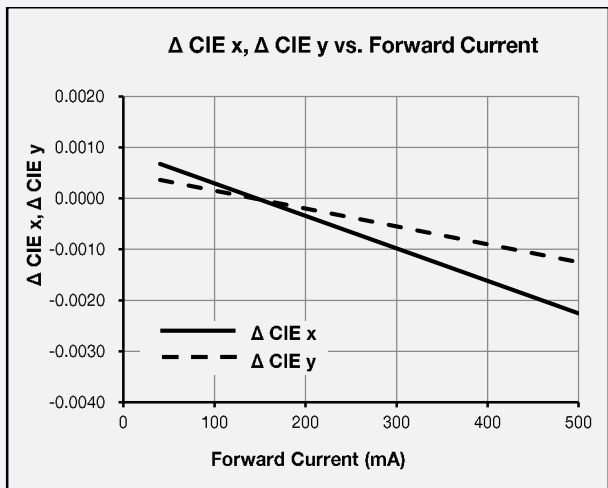
**b) Forward Current Characteristics ( $T_s = 85^\circ\text{C}$ )**



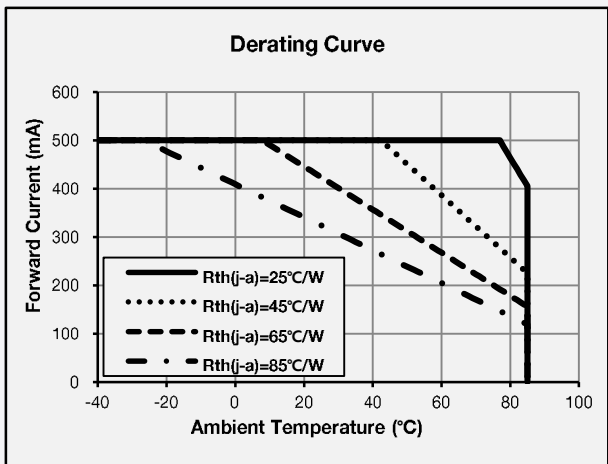
**c) Temperature Characteristics ( $I_f = 150\text{ mA}$ )**



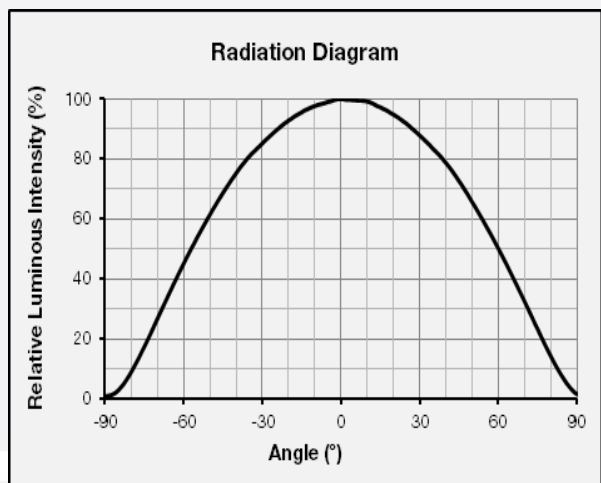
d) Color Shift Characteristics ( $I_f = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )



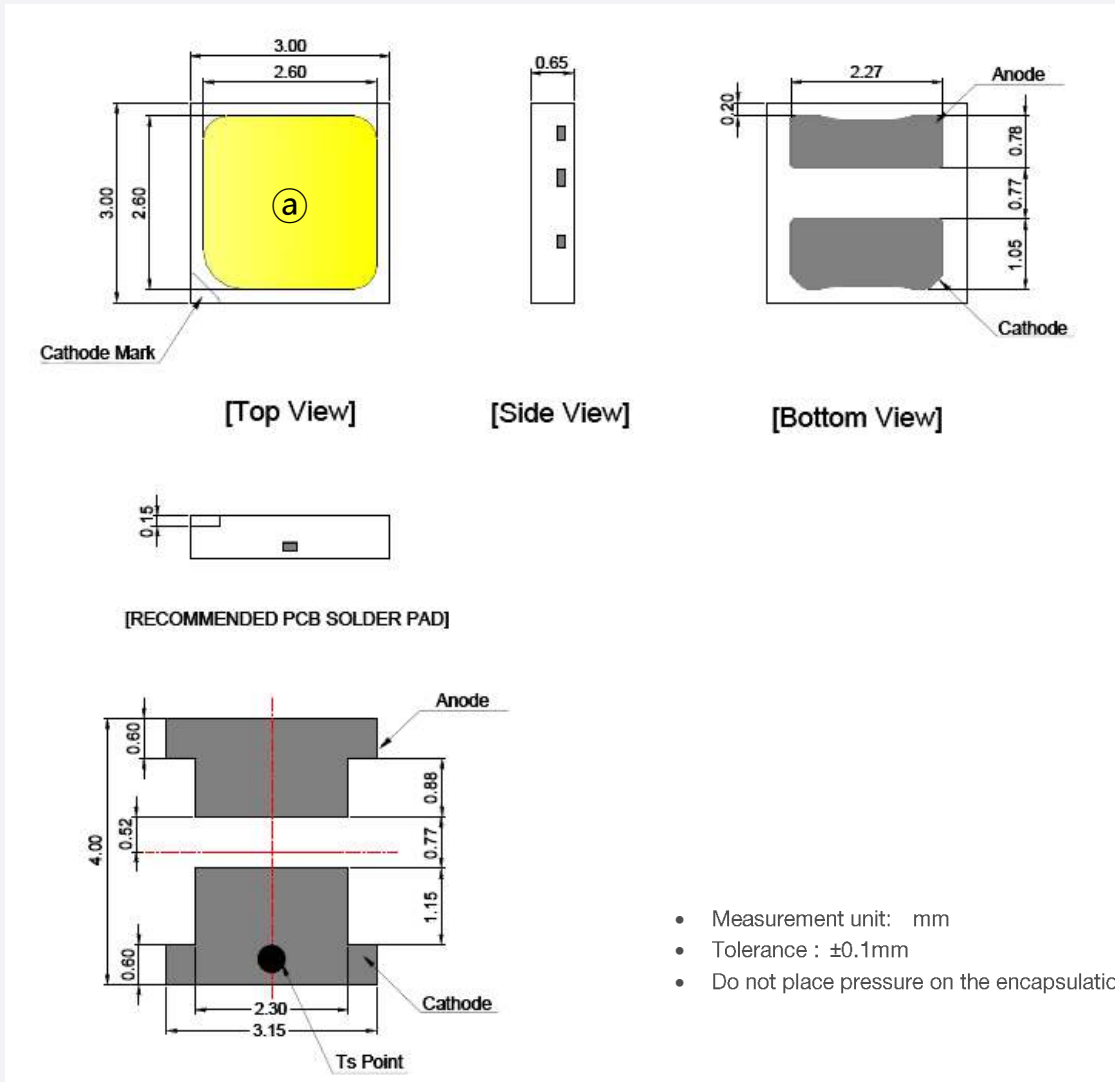
e) Derating Curve



f) Beam Angle Characteristics ( $I_f = 150 \text{ mA}$ ,  $T_s = 85 \text{ }^\circ\text{C}$ )



#### 4. Outline Drawing & Dimension



#### Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2)  $T_s$  point and measurement method:
  - ① Measure one point at the cathode pad, if necessary remove PSR of PCB to reach  $T_s$  point.
  - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

#### Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

## 5. Reliability Test Items & Conditions

### a) Test Items

Test Item	Test Condition	Test Hour / Cycle	Sample No.	
Room Temperature Life Test	25 °C, DC 500 mA	1000 h	22	
High Temperature Life Test	85 °C, DC 500 mA	1000 h	22	
High Temperature Humidity Life Test	85 °C, 85 % RH, DC 500 mA	1000 h	22	
Low Temperature Life Test	-40 °C, DC 500 mA	1000 h	22	
Powered Temperature Cycle Test	-45 °C ~ 85 °C, each 10 min, on/off 5 min Temp. Change time 20min, DC 500 mA	100 cycles	22	
Temperature Cycling	-45 °C / 15 min ↔ 125 °C / 15 min → Hot plate 180°C	500 cycles	100	
High Temperature Storage	120 °C	1000 h	11	
Low Temperature Storage	-40 °C	1000 h	11	
ESD (HBM)		R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 1.5 kΩ	5 times	30
ESD (MM)		R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 0 C: 200 pF V: ±0.5 kV	5 times	30
Vibration Test	20~2000~20 Hz, 200 m/s <sup>2</sup> , sweep 4 min X, Y, Z 3 direction, each 1 cycle	4 cycles	11	
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis	5 cycles	11	

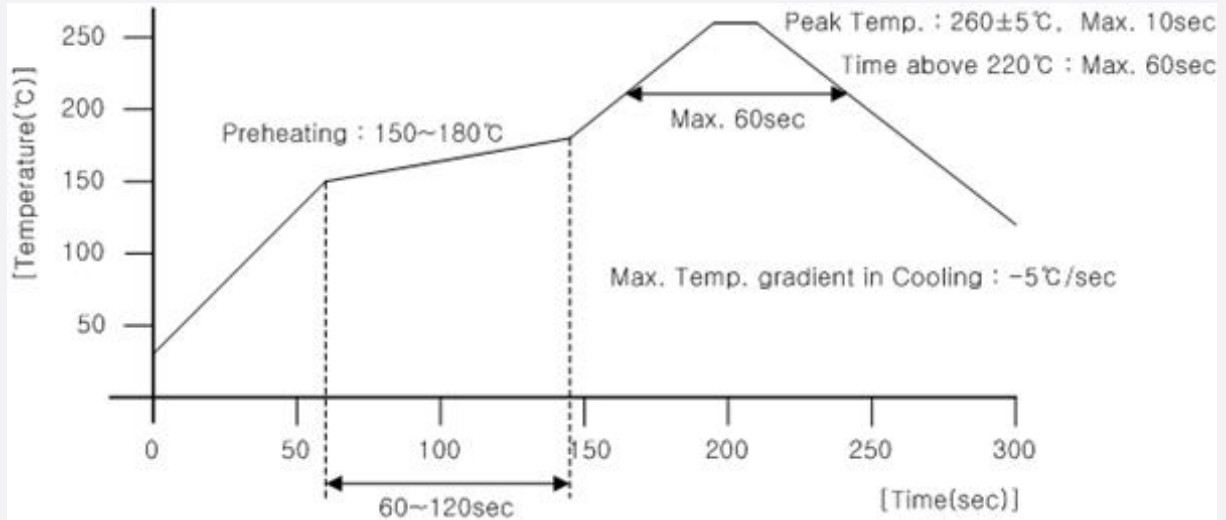
### b) Criteria for Judging the Damage

Item	Symbol	Test Condition (T <sub>s</sub> = 25 °C)	Limit	
			Min	Max
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 500 mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> = 500 mA	Init. Value * 0.7	Init. Value * 1.1

## 6. Soldering Conditions

### a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



### b) Manual Soldering Conditions

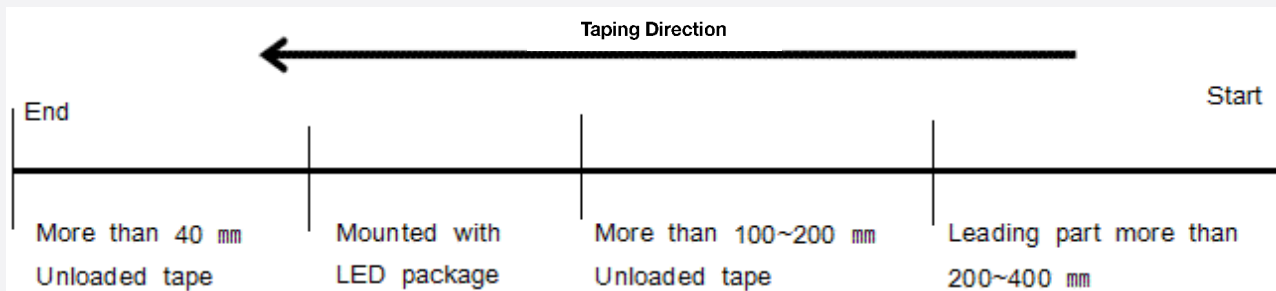
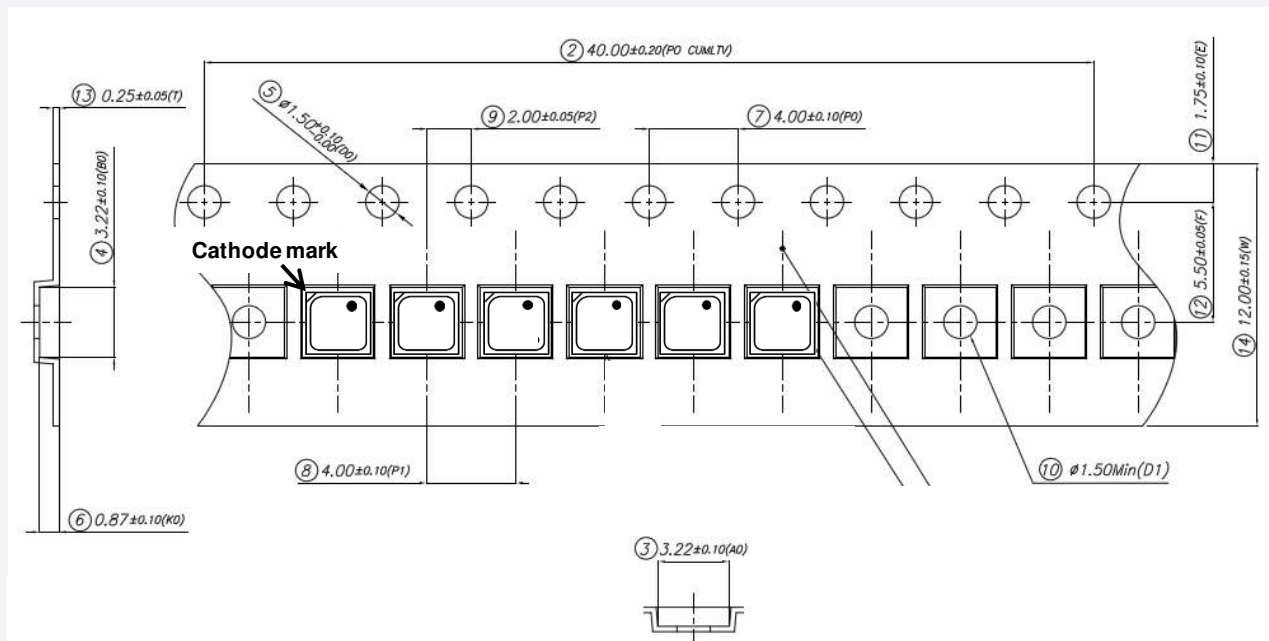
Not more than 5 seconds @ max. 300 °C, under soldering iron.



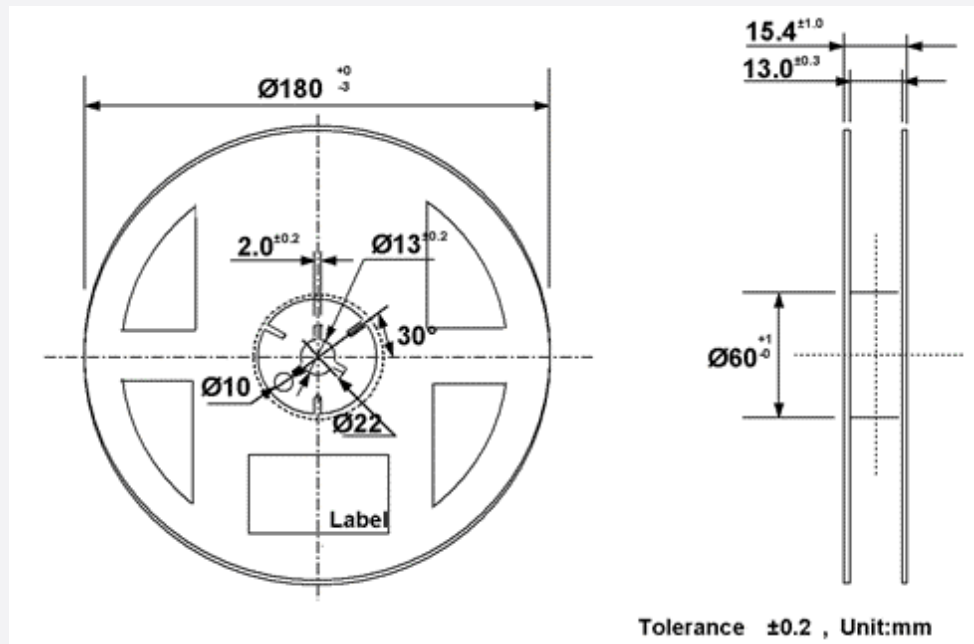
## 7. Tape & Reel

### a) Taping Dimension

(unit: mm)



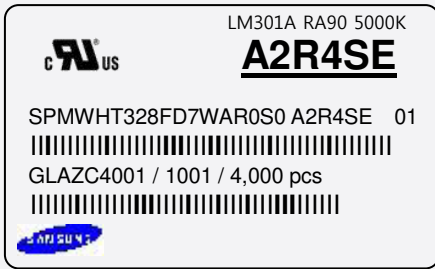
## b) Reel Dimension

**Notes:**

- 1) Quantity: The quantity/reel is 4,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is  $\pm 0.2$  mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at  $10^\circ$  angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

## 8. Label Structure

### a) Label Structure

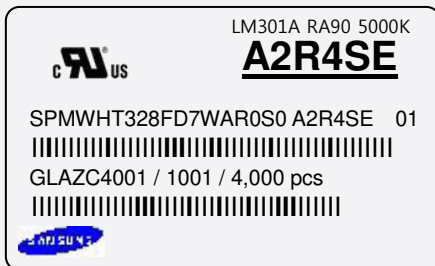


Note: Denoted bin code and product code above is only an example  
'★' means all kind of Chromaticity Coordinate Ranks

Bin Code:

- ⒶⒷ: Forward Voltage bin (refer to page 9)
- ⒸⒹ: Chromaticity bin (refer to page 11~14)
- ⒺⒻ: Luminous Flux bin (refer to page 7)

### b) Lot Number



The lot number is composed of the following characters:

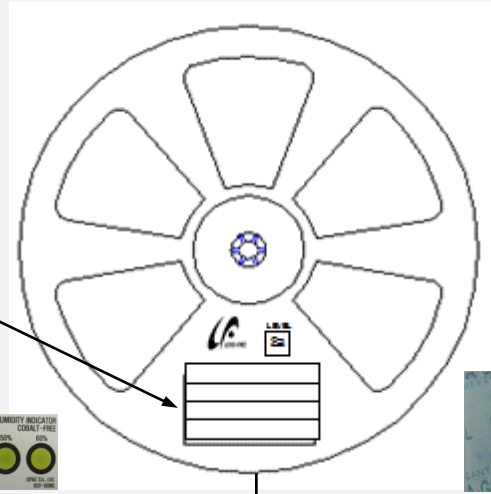
①②③④⑤⑥⑦⑧⑨ / 1ⒶⒷⒸ / 4,000 pcs

- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : L (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B:2017 ...)
- ⑤ : Month (1~9, A, B, C)
- ⑥ : Day (1~9, A, B~V)
- ⑦⑧⑨ : Product serial number (001 ~ 999)
- ⒶⒷⒸ : Reel number (001 ~ 999)

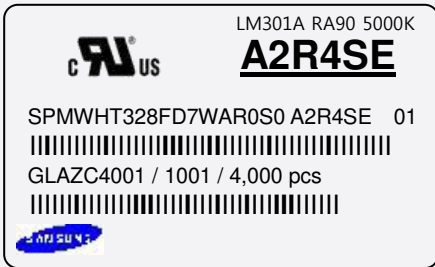
## 9. Packing Structure

### a) Packing Process

Reel



Aluminum Vinyl Packing Bag

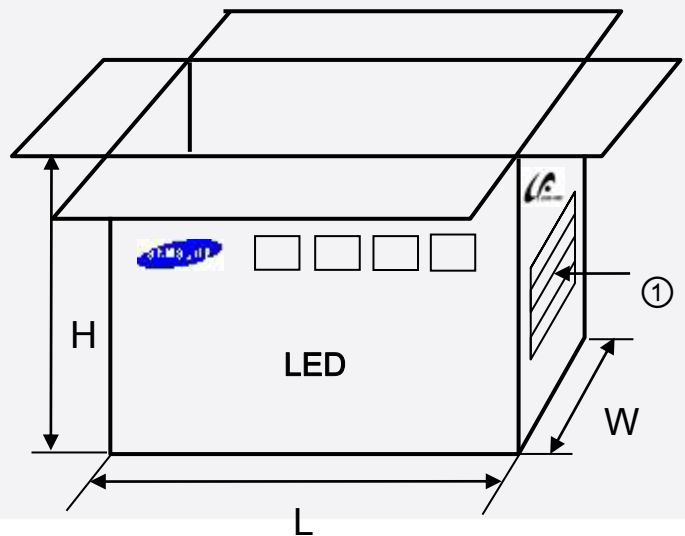
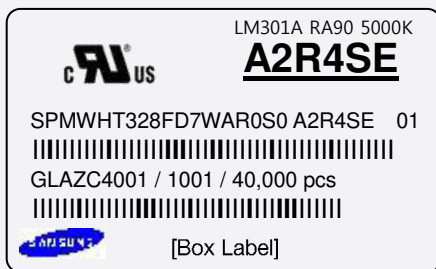


Outer Box

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels

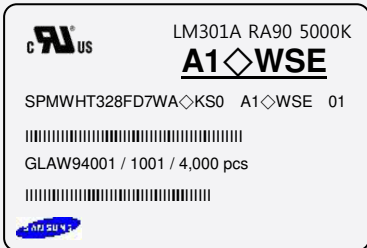
① Side Label



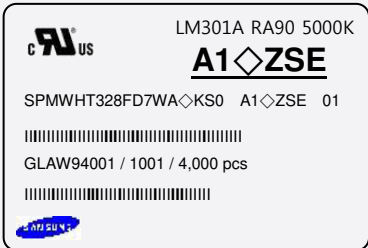
b) Packing Process for kitting

Reel

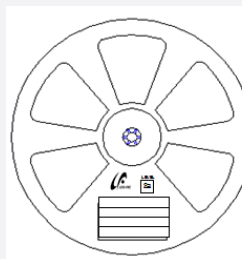
Kitting 'A'



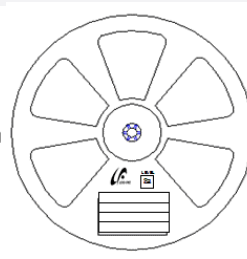
Kitting 'B'



Kitting 'A'

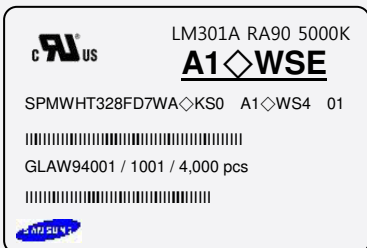


Kitting 'B'

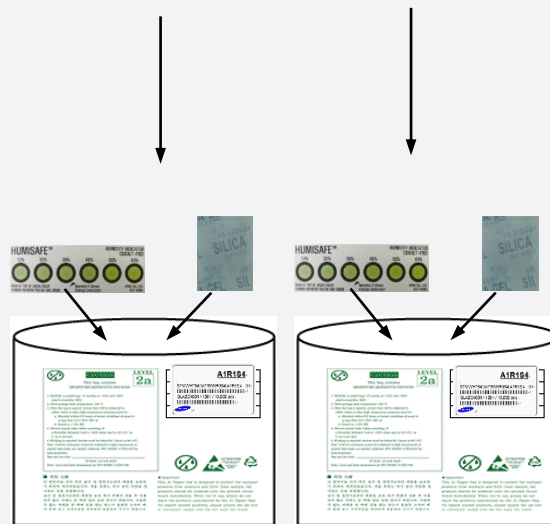
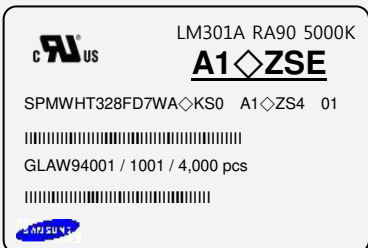


Aluminum Vinyl Packing Bag

Kitting 'A'

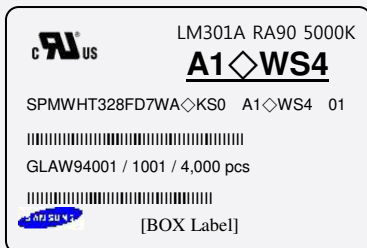


Kitting 'B'

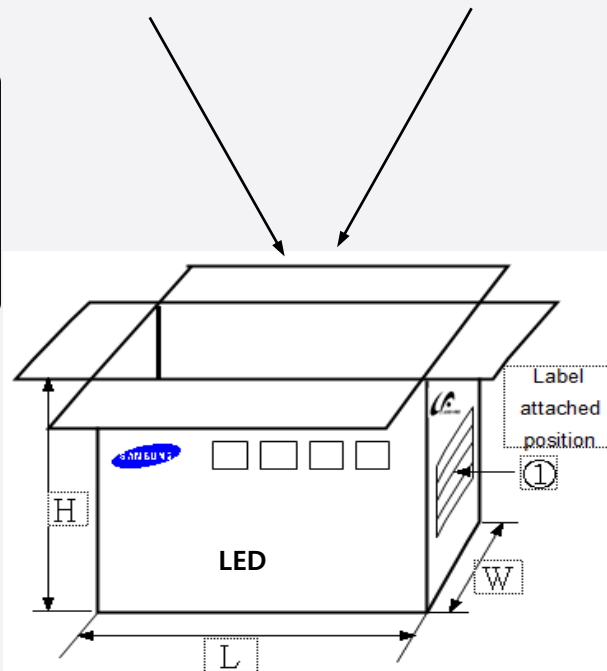
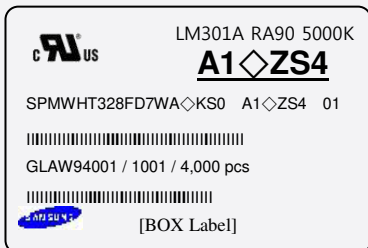


Outer Box

Kitting 'A'



Kitting 'B'



Note: "◇" can be Nominal CCT code.

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

b) Aluminum Vinyl Packing Bag



**CAUTION**

This bag contains  
**MOISTURE SENSITIVE DEVICES**

**LEVEL**  
**2a**

1. Shelf life in sealed bag: 12 months at <math> < 40^{\circ}\text{C}</math> and <math> < 90\%</math> relative humidity (RH)
2. Peak package body temperature: 240 °C
3. After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:
  - a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
  - b. Stored at <math> < 10\%</math> RH
4. Devices require bake, before mounting, if:
  - a. Humidity Indicator Card is >60% when read at 23±5°C, or
  - b. 2a is not met.
5. If baking is required, devices must be baked for 10 ~ 24 hours at 60±5°C

Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: \_\_\_\_\_  
(If blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020



LM301A RA90 5000K  
**A2R4SE**

SPMWHT328FD7WAR0S0 A2R4SE 01  
 |||  
 GLAZC4001 / 1001 / 4,000 pcs  
 |||







**ATTENTION**

OBSEVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
SENSITIVE  
DEVICES



**■ 주의 사항**

이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실시하는 것을 권장합니다.

습기 및 정전기로부터 제품을 보호 하기 위해서 개봉 후 사용하지 않는 자재는 본 팩에 넣어 보관 하시기 바랍니다. 사용하지 않는 자재를 본 팩에 넣을 때는 반드시 동봉된 드라이 팩과 함께 넣고 지퍼부분을 완전하게 밀봉하여 주시기 바랍니다.

**■ Important**

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products., please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag





## 10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
  - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH<sup>\*Note 1</sup>, or
  - b. Mounted within 24 hours (1 day) at an assembly line with a condition of more than 30 °C / 70 % RH<sup>\*Note 2</sup>, or
  - c. Stored at <10 % RH.

\*Note 1, 2: IPC/JEDEC J-STD-033A, Recommended Equivalent Total Floor Life Table

Package Type and Body Thickness	Moisture Sensitivity Level	Maximum Percent Relative Humidity						Temperature
		40%	50%	60%	70%	80%	90%	
Body Thickness <2.1mm	Level 2a	∞	∞	28	1	1	1	30°C
		∞	∞	∞	2	1	1	25°C
		∞	∞	∞	2	2	1	20°C

- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) It is recommended to be baked for 12 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)
 

The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

# Legal and additional information.

## [About Samsung Electronics Co., Ltd.](#)

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies that redefine the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems, and semiconductor and LED solutions. We are also leading in the Internet of Things space with the open platform SmartThings, our broad range of smart devices, and through proactive cross-industry collaboration. We employ 319,000 people across 84 countries with annual sales of US \$196 billion. To discover more, and for the latest news, feature articles and press material, please visit the Samsung Newsroom at [news.samsung.com](http://news.samsung.com).

Copyright © 2016 Samsung Electronics Co., Ltd. All rights reserved.

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies that redefine the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems, and semiconductor and LED solutions. We are also leading in the Internet of Things space with the open platform SmartThings, our broad range of smart devices, and through proactive cross-industry collaboration. We employ 319,000 people across 84 countries with annual sales of US \$196 billion. To discover more, and for the latest news, feature articles and press material, please visit the Samsung Newsroom at [news.samsung.com](http://news.samsung.com).

Samsung Electronics Co., Ltd.  
95, Samsung 2-ro  
Giheung-gu  
Yongin-si, Gyeonggi-do, 446-711  
KOREA

[www.samsungled.com](http://www.samsungled.com)

